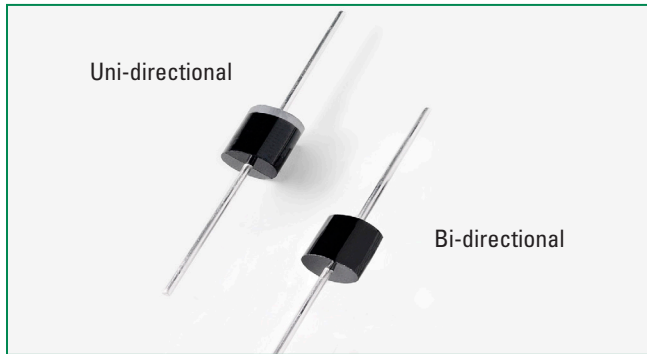


**TP5KP Series**



**Agency Approvals**

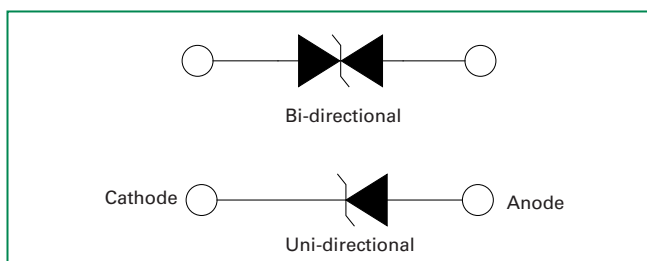
AGENCY	AGENCY FILE NUMBER
	E230531

**Maximum Ratings and Thermal Characteristics (T<sub>A</sub>=25°C unless otherwise noted)**

Parameter	Symbol	Value	Unit
Peak Pulse Power Dissipation by 10/1000µs Test Waveform (Fig.2) (Note 1)	P <sub>PPM</sub>	5000	W
Steady State Power Dissipation on Infinite Heat Sink at T <sub>L</sub> =75°C	P <sub>D</sub>	8.0	W
Peak Forward Surge Current, 8.3ms Single Half Sine Wave Unidirectional Only (Note 2)	I <sub>FSM</sub>	400	A
Maximum Instantaneous Forward Voltage at 100A for Unidirectional Only (Note 3)	V <sub>F</sub>	3.5	V
Operating Junction Temperature Range	T <sub>J</sub>	-55 to 150	°C
Storage Temperature Range	T <sub>STG</sub>	-55 to 175	°C
Typical Thermal Resistance Junction to Lead	R <sub>θJL</sub>	8.0	°C/W
Typical Thermal Resistance Junction to Ambient	R <sub>θJA</sub>	40	°C/W

- Notes:**
1. Non-repetitive current pulse, per Fig. 4 and derated above T<sub>J</sub> (initial) =25°C per Fig. 3.
  2. Measured on 8.3ms single half sine wave or equivalent square wave, duty cycle=4 per minute maximum.

**Functional Diagram**



**Description**

The TP5KP Series is designed specifically to protect sensitive electronic equipment from voltage transients induced by lightning and other transient voltage events.


**Features**

- Hi reliability application and automotive grade AEC Q101 qualified
- Glass passivated chip junction in P600 package
- 5000W peak pulse capability at 10/1000µs waveform, repetition rate (duty cycles):0.01%
- Fast response time: typically less than 1.0ps from 0 Volts to BV min
- Excellent clamping capability
- Typical failure mode is short from over-specified voltage or current
- Whisker test is conducted based on JEDEC JESD201A per its table 4a and 4c
- IEC-61000-4-2 ESD 30kV(Air), 30kV (Contact)
- ESD protection of data lines in accordance with IEC 61000-4-2
- EFT protection of data lines in accordance with IEC 61000-4-4
- Low incremental surge resistance
- Typical I<sub>R</sub> less than 2µA when V<sub>BR</sub> min>12V
- High temperature to reflow soldering guaranteed: 260°C/10sec / 0.375" (9.5mm) lead length, 5 lbs., (2.3kg) tension
- V<sub>BR</sub> @ T<sub>J</sub> = V<sub>BR</sub> @ 25°C x (1 + α T x (T<sub>J</sub> - 25)) (α T: Temperature Coefficient, typical value is 0.1%)
- Plastic package is flammability rated V-0 per Underwriters Laboratories
- Matte tin lead-free plated
- Halogen free and RoHS compliant
- Pb-free E3 means 2<sup>nd</sup> level interconnect is Pb-free and the terminal finish material is tin(Sn) (IPC/ JEDEC J-STD-609A.01)

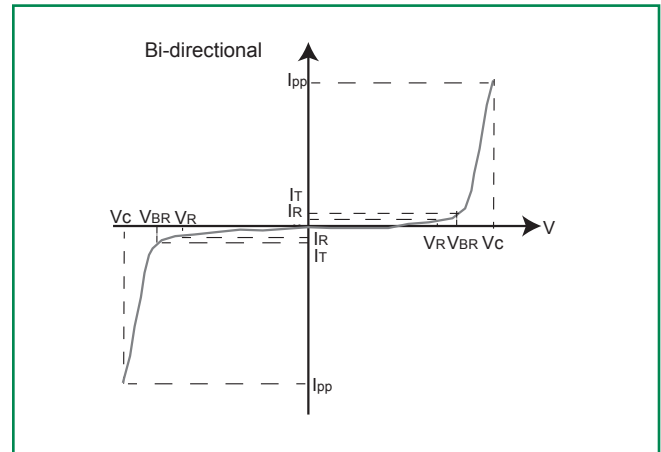
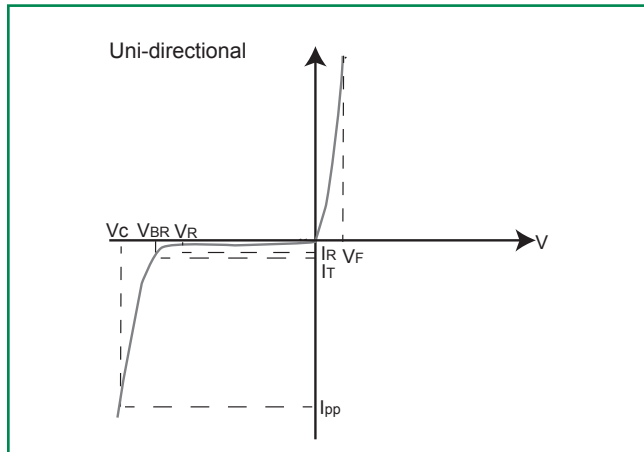
**Applications**

TVS devices are ideal for the protection of I/O interfaces, V<sub>CC</sub> bus and other vulnerable circuits used in telecom, computer, industrial and consumer electronic applications.

### Electrical Characteristics ( $T_A=25^\circ\text{C}$ unless otherwise noted)

Part Number (Uni)	Part Number (Bi)	Reverse Stand off Voltage $V_R$ (Volts)	Breakdown Voltage $V_{BR}$ (Volts) @ $I_T$		Test Current $I_T$ (mA)	Maximum Clamping Voltage $V_C$ @ $I_{PP}$ (V)	Maximum Peak Pulse Current $I_{PP}$ (A)	Maximum Reverse Leakage $I_R$ @ $V_R$ ( $\mu\text{A}$ )	Agency Approval 
			MIN	MAX					
TP5KP11A	TP5KP11CA	11.0	12.20	13.50	5	18.2	280.2	2	X
TP5KP12A	TP5KP12CA	12.0	13.30	14.70	5	19.9	256.3	2	X
TP5KP13A	TP5KP13CA	13.0	14.40	15.90	5	21.5	237.2	2	X
TP5KP14A	TP5KP14CA	14.0	15.60	17.20	5	23.2	219.8	2	X
TP5KP15A	TP5KP15CA	15.0	16.70	18.50	5	24.4	209.0	2	X
TP5KP16A	TP5KP16CA	16.0	17.80	19.70	5	26.0	196.2	2	X
TP5KP17A	TP5KP17CA	17.0	18.90	20.90	5	27.6	184.8	2	X
TP5KP18A	TP5KP18CA	18.0	20.00	22.10	5	29.2	174.7	2	X
TP5KP20A	TP5KP20CA	20.0	22.20	24.50	5	32.4	157.4	2	X
TP5KP22A	TP5KP22CA	22.0	24.00	26.90	5	35.5	143.7	2	X
TP5KP24A	TP5KP24CA	24.0	26.70	29.50	5	38.9	131.1	2	X
TP5KP26A	TP5KP26CA	26.0	28.90	31.90	5	42.1	121.1	2	X
TP5KP28A	TP5KP28CA	28.0	31.10	34.40	5	45.4	112.3	2	X
TP5KP30A	TP5KP30CA	30.0	33.30	36.80	5	48.4	105.4	2	X
TP5KP33A	TP5KP33CA	33.0	36.70	40.60	5	53.3	95.7	2	X
TP5KP36A	TP5KP36CA	36.0	40.00	44.20	5	58.1	87.8	2	X
TP5KP40A	TP5KP40CA	40.0	44.40	49.10	5	64.5	79.1	2	X
TP5KP43A	TP5KP43CA	43.0	47.80	52.80	5	69.4	73.5	2	X
TP5KP45A	TP5KP45CA	45.0	50.00	55.30	5	72.7	70.2	2	X
TP5KP48A	TP5KP48CA	48.0	53.30	58.90	5	77.4	65.9	2	X
TP5KP51A	TP5KP51CA	51.0	56.70	62.70	5	82.4	61.9	2	X
TP5KP54A	TP5KP54CA	54.0	60.00	66.30	5	87.1	58.6	2	X
TP5KP58A	TP5KP58CA	58.0	64.40	71.20	5	93.6	54.5	2	X
TP5KP60A	TP5KP60CA	60.0	66.70	73.70	5	96.8	52.7	2	X

### I-V Curve Characteristics



**$P_{PPM}$  Peak Pulse Power Dissipation** – Max power dissipation

**$V_R$  Stand-off Voltage** – Maximum voltage that can be applied to the TVS without operation

**$V_{BR}$  Breakdown Voltage** – Maximum voltage that flows through the TVS at a specified test current ( $I_T$ )

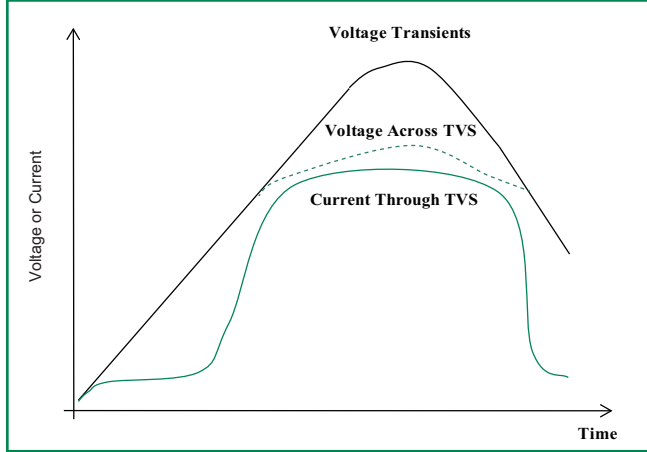
**$V_C$  Clamping Voltage** – Peak voltage measured across the TVS at a specified  $I_{ppm}$  (peak impulse current)

**$I_R$  Reverse Leakage Current** – Current measured at  $V_R$

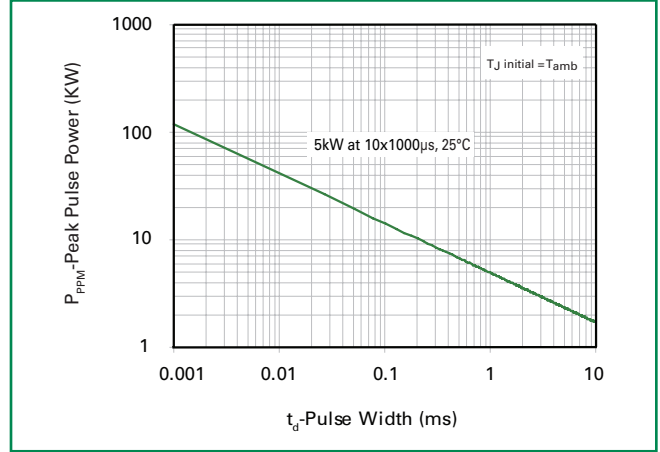
**$V_F$  Forward Voltage Drop for Uni-directional**

### Ratings and Characteristic Curves ( $T_A=25^\circ\text{C}$ unless otherwise noted)

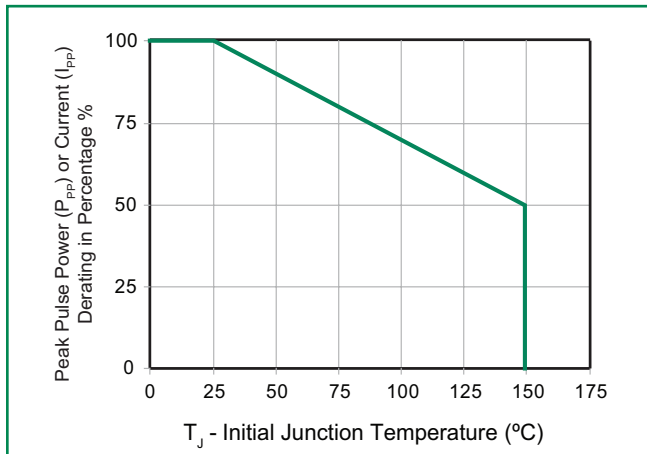
**Figure 1 - TVS Transients Clamping Waveform**



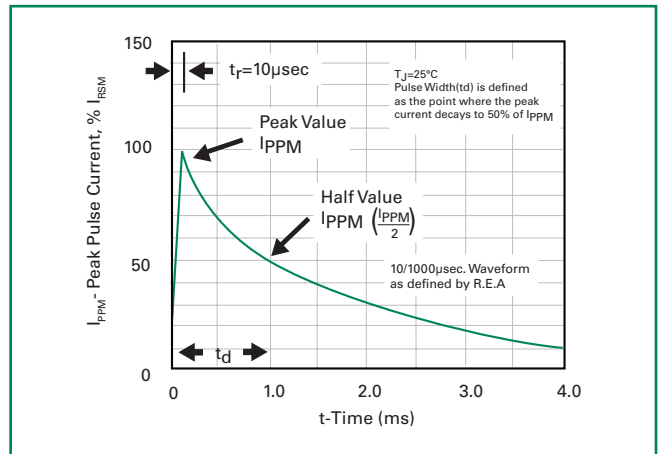
**Figure 2 - Peak Pulse Power Rating Curve**



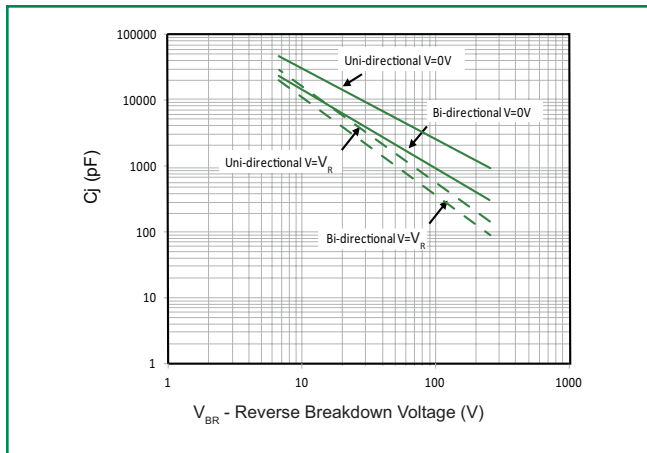
**Figure 3 - Peak Pulse Power Derating Curve**



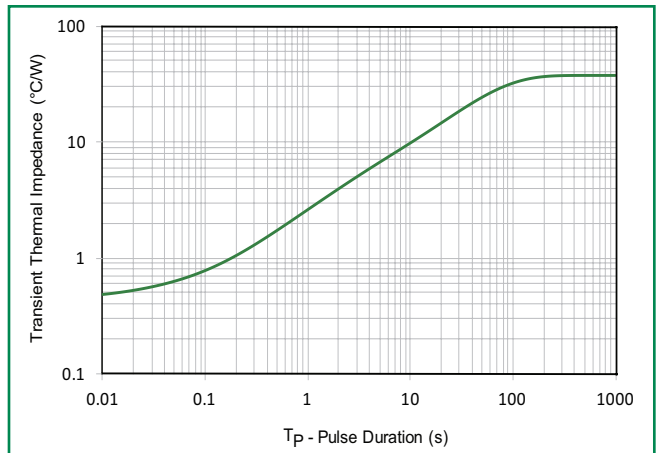
**Figure 4 - Pulse Waveform**



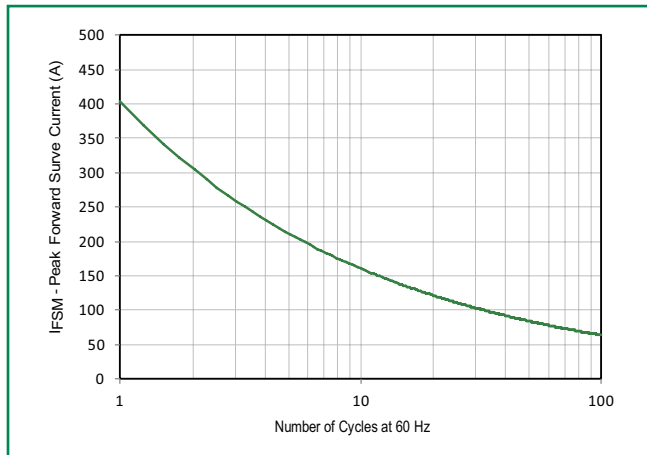
**Figure 5 - Typical Junction Capacitance**



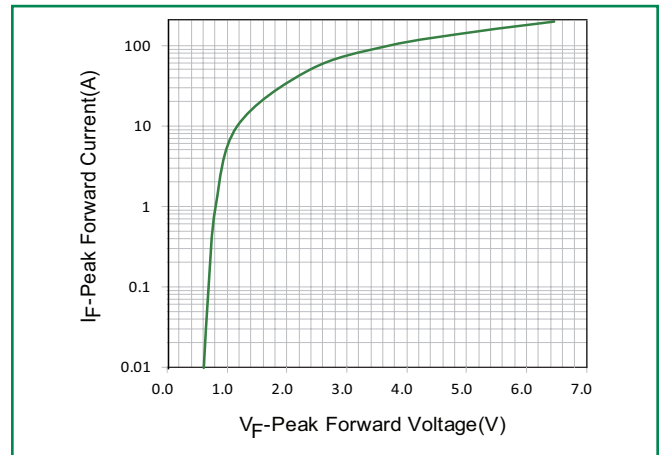
**Figure 6 - Typical Transient Thermal Impedance**



**Figure 7 - Maximum Non-Repetitive Peak Forward Surge Current Uni-Directional Only**

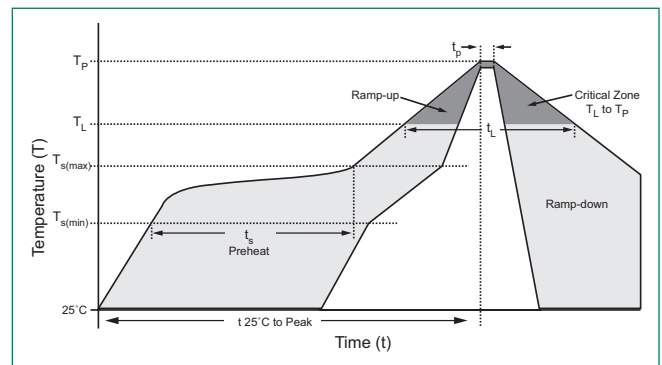


**Figure 8 - Peak Forward Voltage Drop vs Peak Forward Current (Typical Values)**



**Soldering Parameters**

Reflow Condition		Lead-free assembly
Pre Heat	- Temperature Min ( $T_{s(min)}$ )	150°C
	- Temperature Max ( $T_{s(max)}$ )	200°C
	- Time (min to max) ( $t_s$ )	60 – 180 secs
Average ramp up rate (Liquidus Temp ( $T_A$ ) to peak)		3°C/second max
$T_{s(max)}$ to $T_A$ - Ramp-up Rate		3°C/second max
Reflow	- Temperature ( $T_A$ ) (Liquidus)	217°C
	- Time (min to max) ( $t_s$ )	60 – 150 seconds
Peak Temperature ( $T_p$ )		260 <sup>+0/-5</sup> °C
Time within 5°C of actual peak Temperature ( $t_p$ )		20 – 40 seconds
Ramp-down Rate		6°C/second max
Time 25°C to peak Temperature ( $T_p$ )		8 minutes Max.
Do not exceed		260°C



**Flow/Wave Soldering (Solder Dipping)**

<b>Peak Temperature :</b>	265°C
<b>Dipping Time :</b>	10 seconds
<b>Soldering :</b>	1 time

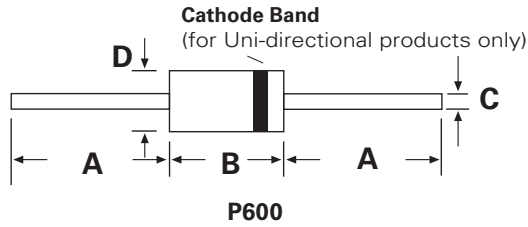
**Physical Specifications**

<b>Weight</b>	0.07oz., 2.1g
<b>Case</b>	P600 molded plastic body over passivated junction.
<b>Polarity</b>	Color band denotes the cathode except Bipolar.
<b>Terminal</b>	Matte Tin axial leads, solderable per JESD22-B102.

**Environmental Specifications**

<b>High Temp. Storage</b>	JESD22-A103
<b>HTRB</b>	JESD22-A108
<b>Temperature Cycling</b>	JESD22-A104
<b>H3TRB</b>	JESD22-A101
<b>RSH</b>	JESD22-B106

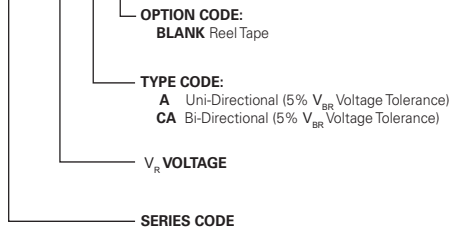
### Dimensions



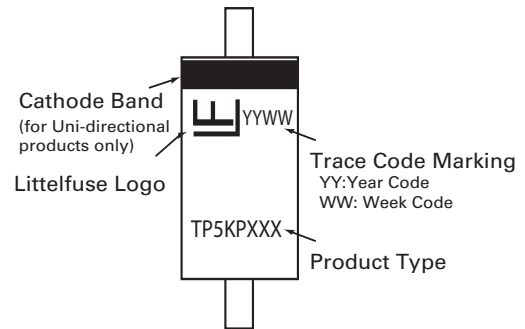
Dimensions	Inches		Millimeters	
	Min	Max	Min	Max
A	1.000	-	25.40	-
B	0.340	0.360	8.60	9.10
C	0.048	0.052	1.22	1.32
D	0.340	0.360	8.60	9.10

### Part Numbering System

TP5KPxxxXX X



### Part Marking System



### Packing Options

Part Number	Component Package	Quantity	Packaging Option	Packaging Specification
TP5KPxxxXX	P600	800	Tape & Reel	EIA STD RS-296

### Tape and Reel Specification

